

1. 2021년 교육 계획

분기	차수	일시	내용	정원
1/4	63차	2021.01.21	Basic Course: Microstructures Sample preparation for Metallurgy	10명
	64차	2021.02.25	Basic Course: Microstructures Sample preparation for Electronic Materials	10명
	86차	2021.03.11	MultiPrep System Users Meeting : Cross-Section/ TEM Wedge Sample Preparation	6명
2/4	65차	2021.04.08	Basic Course: Microstructures Sample preparation for Metallurgy	10명
	66차	2021.05.13	Basic Course: Microstructures Sample preparation for Electronic Materials	10명
	87차	2021.06.17	MultiPrep System Users Meeting : Parallel Thinning for Die & Package Analysis	6명
3/4	67차	2021.07.15	Basic Course: Microstructures Sample preparation for Metallurgy	10명
	68차	2021.08.19	Basic Course: Microstructures Sample preparation for Electronic Materials	10명
	88차	2021.09.09	MultiPrep System Users Meeting : Cross-Section/ TEM Wedge Sample Preparation	6명
4/4	69차	2021.10.14	Basic Course: Microstructures Sample preparation for Metallurgy	10명
	70차	2021.11.18	Basic Course: Microstructures Sample preparation for Electronic Materials	10명
	89차	2021.12.09	MultiPrep System Users Meeting : Parallel Thinning for Die & Package Analysis	6명